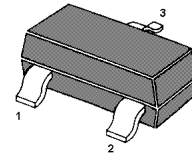
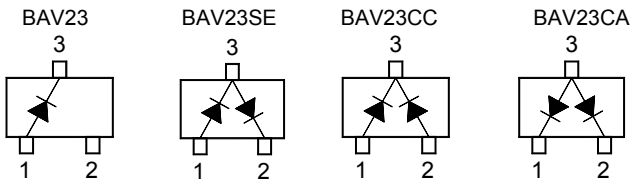


# BAV23 / SE / CC / CA

## Silicon Epitaxial Planar Diodes

High voltage switching diode



BAV23 Marking Code: **HC**  
 BAV23SE Marking Code: **PY**  
 BAV23CC Marking Code: **PZ**  
 BAV23CA Marking Code: **RA**  
 SOT-23 Plastic Package

### Absolute Maximum Ratings ( $T_a = 25^\circ\text{C}$ )

Parameter	Symbol	Value	Unit
Maximum Repetitive Reverse Voltage	$V_{RRM}$	250	V
Reverse Voltage	$V_R$	200	V
Forward Current	$I_{F(AV)}$	400	mA
Repetitive Peak Forward Current	$I_{FRM}$	625	mA
Non-repetitive Peak Forward Surge Current	$I_{FSM}$	1.7 3 9	A
		at $t = 10\text{ ms}$ at $t = 100\ \mu\text{s}$ at $t = 1\ \mu\text{s}$	
Power Dissipation	$P_{tot}$	350	mW
Thermal Resistance Junction to Ambient Air	$R_{\theta JA}$	357	$^\circ\text{C/W}$
Operating Junction and Storage Temperature Range	$T_j, T_{stg}$	- 65 to + 150	$^\circ\text{C}$

### Characteristics at $T_a = 25^\circ$

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 100\ \mu\text{A}$	$V_{(BR)R}$	250	-	V
Forward Voltage at $I_F = 100\text{ mA}$ at $I_F = 200\text{ mA}$	$V_F$	- -	1 1.25	V
Reverse Current at $V_R = 200\text{ V}, T_j = 25^\circ\text{C}$ at $V_R = 200\text{ V}, T_j = 150^\circ\text{C}$	$I_R$	- -	100 100	nA $\mu\text{A}$
Total Capacitance at $V_R = 0\text{ V}, f = 1\text{ MHz}$	$C_{tot}$	-	5	pF
Reverse Recovery Time at $I_F = I_R = 30\text{ mA}, I_{tr} = 0.1 \times I_R, R_L = 100\ \Omega$	$t_{rr}$	-	50	ns

**TOP DYNAMIC**



ISO14001 : 2004 Certificate No. 121505007  
 ISO 9001 : 2008 Certificate No. 50114012  
 OHSAS 18001 : 2007 Certificate No. 05131506008  
 IECQ QC 080000 Certificate No. ECUH1000714102

Dated : 22/03/2012 Rev:01

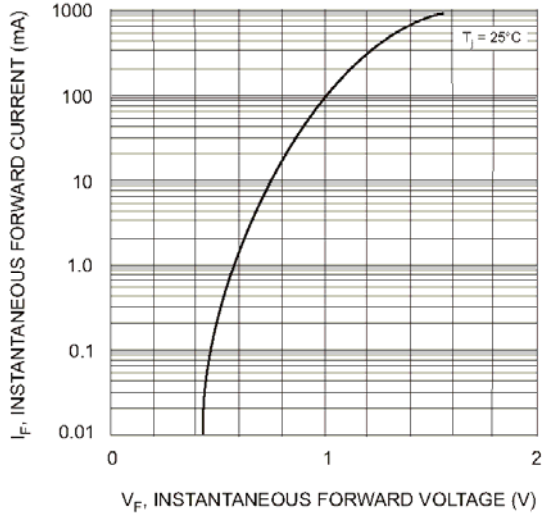


Fig. 1 Forward Characteristics

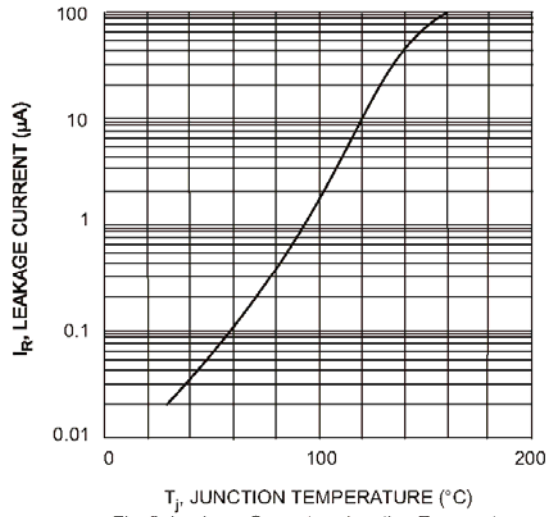


Fig. 2 Leakage Current vs Junction Temperature